

Datasheet

Multilayer Ceramic Band Pass Filter, 2.4 GHz ISM Band Working Frequency, RFBPF Series – 2012(0805) RS Stock number 884-2168

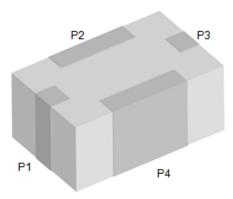
FEATURES

- Miniature footprint: 2.0 X 1.2 X 0.9 mm³
- 2. Low Profile Thickness
- 3. Low Insertion loss (Typical-1.5dB)
- 4. High Rejection Rate
- High attenuation on 2nd harmonic suppressed
- LTCC process

APPLICATIONS

- 1. 2.4GHz ISM band RF applications
- Bluetooth, Wireless LAN 802.11b/g, HomeRF

CONSTRUCTION



PIN	Connection		
1	I/O port		
2	Ground		
3	I/O port		
4	Ground		

Fig1. Outline of 2.4GHz Band Pass Filter 2012 size

DIMENSIONS

Figure	Symbol	Dimension (mm)
L T	L	2.00 ± 0.15
E	w	1.25 ± 0.15
≥ B	Т	0.90 ± 0.10
	А	1.00 ± 0.15
C A	В	0.30 ± 0.15
	С	0.50 ± 0.15
	D	0.25 ± 0.15
	E	0.25 ± 0.15



ELECTRICAL CHARACTERISTICS

RFBPF2012090A1T	Specification		
Frequencyrange	2450 ± 50 MHz		
InsertionLoss	1.7 dB max		
VSWR	2.0 max		
Impedance (Unbalanced)	50 Ω		
Operation Temperature Range	-40□ ~ +85□		
	30dB @ 900MHz		
Attenuation (min.)	20dB @ 1850 MHz		
	30dB @ 4800 MHz		

Typical Electrical Chart



SOLDER LAND PATTERN

Figure	Symbol	Dimension (mm)
	L1	1.30 ± 0.10
← L1	L2	0.50 ± 0.05
φ Î _{wi}	L3	0.60 ± 0.05
$\begin{array}{c} & & & & & & & & & & & & & & & & & & &$	L4	0.40 ± 0.05
	L5	0.50 ± 0.05
	W1	0.75 ± 0.10
	W2	1.00 ± 0.10
	W3	0.40 ± 0.05
	W4	0.75 ± 0.05
	S1	0.50 ± 0.05
Line width to be decign to match 500 characteristic immediates	S2	0.25 ± 0.05
Line width to be design to match 50Ω characteristic impedance, depending on PCB material and thickness.	S3	0.30 ± 0.05
Φ are the grounding through holes.	Ф	0.40 ± 0.10



RELIABILITYTEST

ENGLISH

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature: 235±5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time: 2±0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder: Sn3Ag0.5Cu for lead-free	
Leaching	*Solder bath temperature: 260±5°C	Loss of metallization on the edges of each
(Resistance to	*Leachingimmersiontime: 30±0.5 sec	electro de shall not exceed 25%.
dissolution of	Solder: SN63A	
metallization)		
IEC 60068-2-58		
Resistance to soldering heat	*Preheating temperature: 120~150℃,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Soldertemperature: 270±5°C	descriptions in electrical characteristics unde
	*Immersion time: 10±1 sec	the operational temperature range within-40
		~ 85°C.
	Solder: Sn3Ag0.5Cu for lead-free	Loss of metallization on the edges of each
	Measurement to be made after keeping at	electro de shall not exceed 25%.
	room temperature for 24±2 hrs	
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044	*Test Surface: Rigid surface of concrete or	Electrical specification shall satisfy the
Customer's specification.	steel.	descriptions in electrical characteristics unde
		the operational temperature range within -40
	*Times: 6 surfaces for each units; 2 times	~85°C.
	for each side.	00 0.
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude: 1.5mm	Electrical specification shall satisfy the
	*Test times : 6hrs.(Two hrs eachin three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
	mutuany perpendicular directions)	~ 85°C.
Adhesive Strength		
of Termination	*Pressurizing force :	No remarkable damage or removal of the
JIS C 0051- 7.4.3	5N(≤ 0603); 10N(>0603)	termination.
	*Testtime: 10±1 sec	
Bendingtest	The middle part of substrate shall be	No mechanical damage.
JIS C 0051- 7.4.1	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	



Temperature cycle JIS C 0025	 30±3 minutes at -40°C±3°C, 	No mechanical damage.
013 0 0025	2. 10~15 minutes at room temperature,	Electrical specification shall satisfy the
	 30±3 minutes at +85°C±3°C, 	descriptions in electrical characteristics
	4. 10~15 minutes at room temperature.	under the operational temperature range
	Total 100 continuous cycles	within -40 ~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
High temperature	*Temperature: 85°C±2°C	No mechanical damage.
JIS C 0021	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
	Measurement to be made after keeping at	descriptions in electrical characteristics under
	room temperature for 24±2 hrs	the operational temperature range within -40
	Toom tomporature for 2422 ms	~ 85°C.
Humidity	*Humidity: 90% to 95% R.H.	No mechanical damage.
(steady conditions)	*Temperature: 40±2°C	Electrical specification shall satisfy the
JIS C 0022	*Time: 1000+24/-0 hrs.	descriptions in electrical characteristics under
	Measurement to be made after keeping at	the operational temperature range within -40
	room temperature for 24±2 hrs	~ 85°C.
	1000hrs data	
Low temperature	*Temperature: -40°C±2°C	No mechanical damage.
JIS C 0020	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
	Measurement to be made after keeping at	descriptions in electrical characteristics under
	room temperature for 24±2 hrs	the operational temperature range within -40
		~ 85°C.



SOLDERING CONDITION

ENGLISH

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

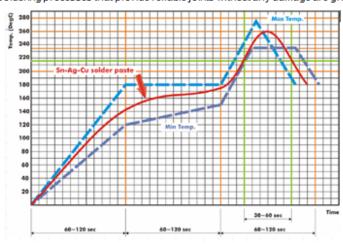


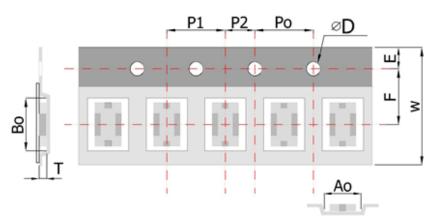
Fig2. Infrared soldering profile

ORDERING CODE

RF	BPF	201209	0	Α	1	T
Walsin.	Product Code	Dimension code	Unit of	Application	Specification	Packing
RF Pb free	BPF: Band Pass	Per 2 digits of	dimension	A:2.4GHzISM	Design Code	T : Reeled
device	Filter	Length, Width,	0 : 0.1 mm	Band		
		Thickness:	1:1.0 mm			
		e.g.:				
		201209=				
		Length 20,				
		Width 12,				
		Thickness 09				

Minimum Ordering Quantity: 2000 pcs per reel.

PACKAGING

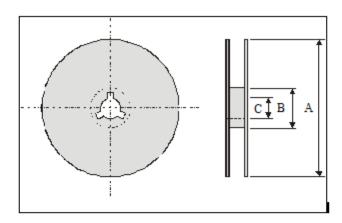


Plastic Tape specifications (unit: mm)

Index	Ao	Во	ФD	Т	W
Dimension (mm)	1.30 ± 0.10	2.30 ± 0.10	1.55 ± 0.10	0.95 ± 0.10	8.00 ± 0.30
Index	E	F	Po	P1	P2
Dimension (mm)	1.75± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00± 0.10



Reel dimensions



Index	Α	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity: 2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

■ Temperature : -10 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.